

ABSTRACT

At least one base material having a wiring circuit that has been formed into a
5 predetermined outer shape is bonded to a motherboard. The motherboard wiring board
and the base material having a wiring circuit are electrically connected to each other at
least one portion through an inner via hole. The outer shape of the base material having
a wiring circuit is smaller than the outer shape of the motherboard, with the base
material having a wiring circuit having an island shape on the motherboard.